Lonten N-channel 650V, 4A, 930mΩ LonFET™ Power MOSFET

Description

LonFET™ Power MOSFET is fabricated using advanced super junction technology. The resulting device has extremely low on resistance, making it especially suitable for applications which require superior power density and outstanding efficiency.

Features

- Ultra low $R_{DS(on)}$
- Ultra low gate charge (typ. Q_g = 13.6nC)
- 100% UIS tested
- RoHS compliant

Applications

- Power faction correction (PFC).
- Switched mode power supplies (SMPS).
- Uninterruptible power supply (UPS).

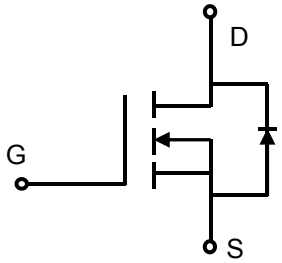
Product Summary

V_{DS} @ $T_{j,max}$	700V
$R_{DS(on),max}$	930mΩ
I_{DM}	12A
$Q_{g,typ}$	13.6nC

TO-251

TO-252

TO-220MF



N-Channel MOSFET

Pb

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	650	V
Continuous drain current (T_C = 25°C)	I_D	4	A
(T_C = 100°C)		2.5	A
Pulsed drain current [1]	I_{DM}	12	A
Gate-Source voltage	V_{GSS}	±30	V
Avalanche energy, single pulse [2]	E_{AS}	120	mJ
Avalanche energy, repetitive [3]	E_{AR}	0.6	mJ
Avalanche current, repetitive [3]	I_{AR}	4	A
Power Dissipation TO-220MF (T_C = 25°C)	P_D	29	W
- Derate above 25°C		0.23	W/°C
Power Dissipation TO-251/ TO-252(TC = 25°C)		50	W
- Derate above 25°C		0.4	W/°C
Mounting torque To-220MF (M2.5 screws)		50	Ncm
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C
Continuous diode forward current	I_S	4	A
Diode pulse current	$I_{S,pulse}$	12	A

Thermal Characteristics TO-251/TO-252

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62	°C/W
Soldering temperature, wavesoldering only allowed at leads. (1.6mm from case for 10s)	T_{sold}	260	°C

Thermal Characteristics TO-220MF

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	4.3	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	80	°C/W
Soldering temperature, wavesoldering only allowed at leads. (1.6mm from case for 10s)	T_{sold}	260	°C

Package Marking and Ordering Information

Device	Device Package	Marking	Units/Tube	Units/Real
LSD65R930GT	TO-220MF	LSD65R930GT	50	
LSG65R930GT	TO-252	LSG65R930GT		2500
LSH65R930GT	TO-251	LSH65R930GT	72	

Electrical Characteristics

T_c = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV_{DSS}	V_{GS}=0 V, I_D=0.25 mA	650	-	-	V
Gate threshold voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=0.25mA	2.5	3.5	4.5	V
Drain cut-off current	I_{DSS}	V_{DS}=650 V, V_{GS}=0 V,				μA
		T_j = 25°C	-	-	1	
		T_j = 125°C	-	10	-	
Gate leakage current, Forward	I_{GSSF}	V_{GS}=30 V, V_{DS}=0 V	-	-	50	nA
Gate leakage current, Reverse	I_{GSSR}	V_{GS}=-30 V, V_{DS}=0 V	-	-	-50	nA
Drain-source on-state resistance	$R_{DS(on)}$	V_{GS}=10 V, I_D=2A	-			
		T_j = 25°C	-	0.82	0.93	Ω
		T_j = 150°C	-	1.9	-	
Gate resistance	R_G	f=1 MHz, open drain	-	8	-	Ω
Dynamic characteristics						
Input capacitance	C_{iss}	V_{DS} = 100 V, V_{GS} = 0 V,	-	349	-	
Output capacitance	C_{oss}	f = 250 kHz	-	15.9	-	pF
Reverse transfer capacitance	C_{rss}		-	1.73	-	
Turn-on delay time	$t_{d(on)}$	V_{DD} = 300 V, I_D = 2 A	-	18.9	-	
Rise time	t_r	R_G = 12Ω, V_{GS}=10 V	-	23	-	ns
Turn-off delay time	$t_{d(off)}$		-	43.6	-	
Fall time	t_f		-	11.5	-	

Gate charge characteristics						
Gate to source charge	Q_{gs}	V_{DD}=480 V, I_D=2 A,	-	4.1	-	nC
Gate to drain charge	Q_{gd}	V_{GS}=0 to 10 V	-	5.7	-	
Gate charge total	Q_g		-	13.6	-	
	$V_{plateau}$		-	6	-	V
Reverse diode characteristics						
Diode forward voltage	V_{SD}	V_{GS}=0 V, I_F=2 A	-	1.0	-	V
Reverse recovery time	t_{rr}	V_R=50 V, I_F=4 A,	-	216	-	ns
Reverse recovery charge	Q_{rr}	dI_F/dt=100 A/μs	-	1.4	-	μC
Peak reverse recovery current	I_{rrm}		-	13	-	A

Notes:

1. Limited by maximum junction temperature, maximum duty cycle is 0.75.

2. I_{AS} = 2A, V_{DD} = 60V, Starting T_j= 25°C.

3. Repetitive Rating: Pulse width limited by maximum junction temperature.

Electrical Characteristics Diagrams

Figure 1. On-Region Characteristics

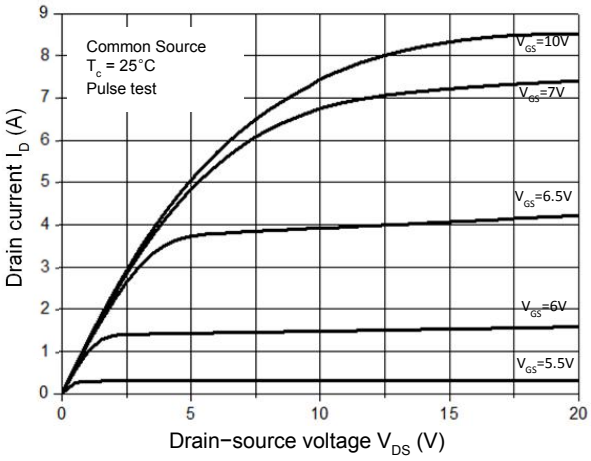


Figure 2. Transfer Characteristics

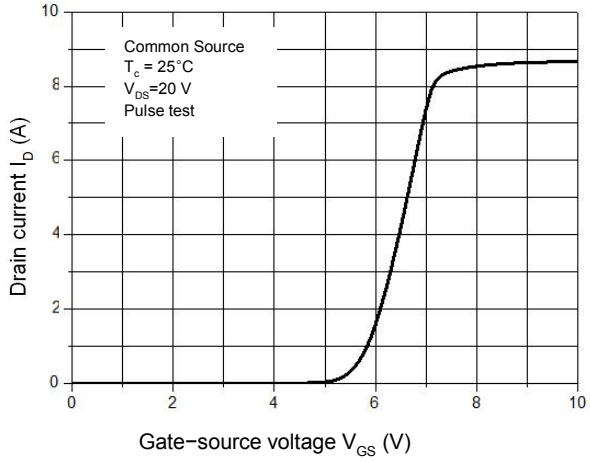


Figure 3. On-Resistance Variation vs. Drain Current

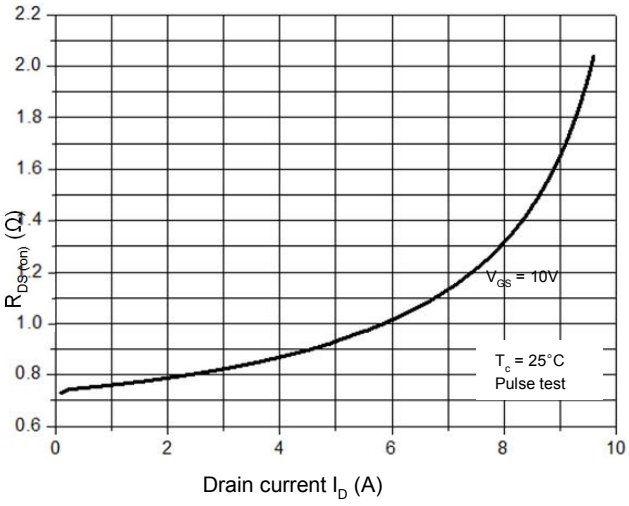


Figure 4. Threshold Voltage vs. Temperature

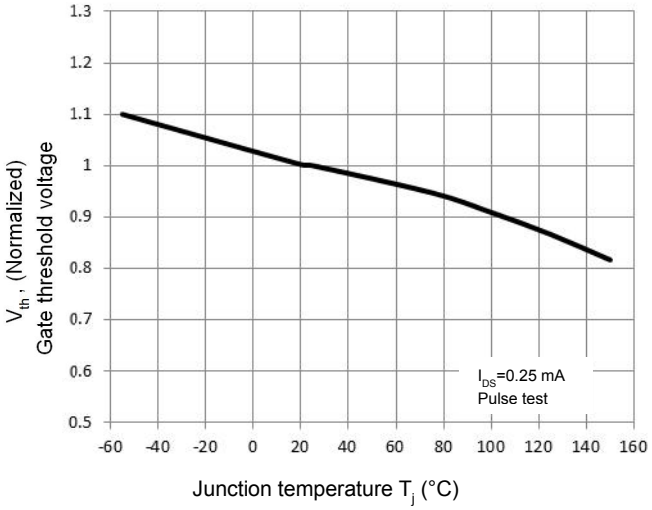


Figure 5. Breakdown Voltage vs. Temperature

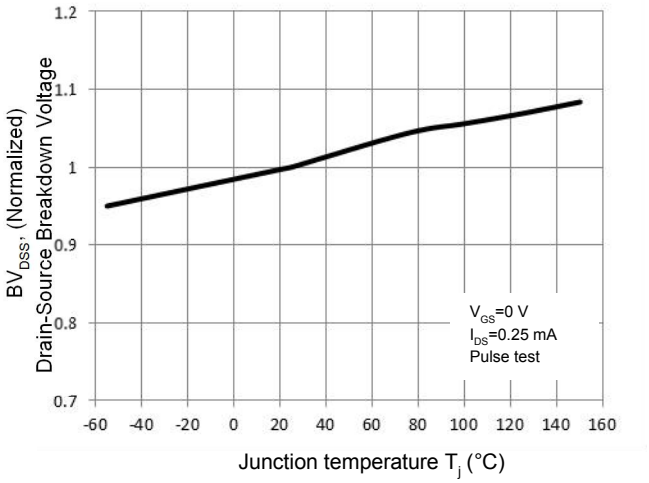


Figure 6. On-Resistance vs. Temperature

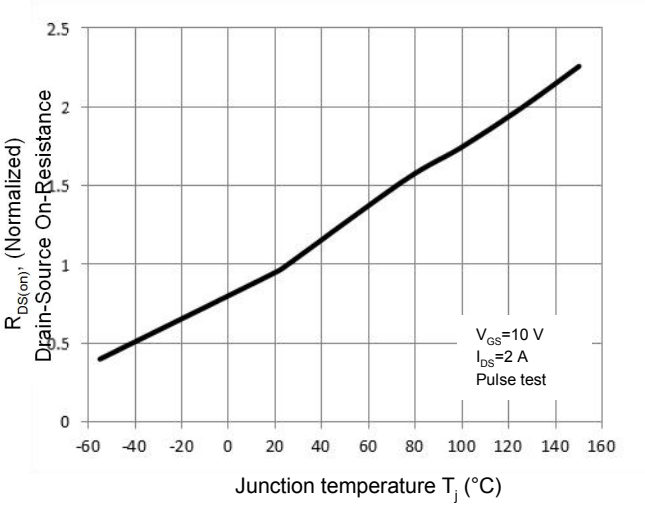


Figure 7. Capacitance Characteristics

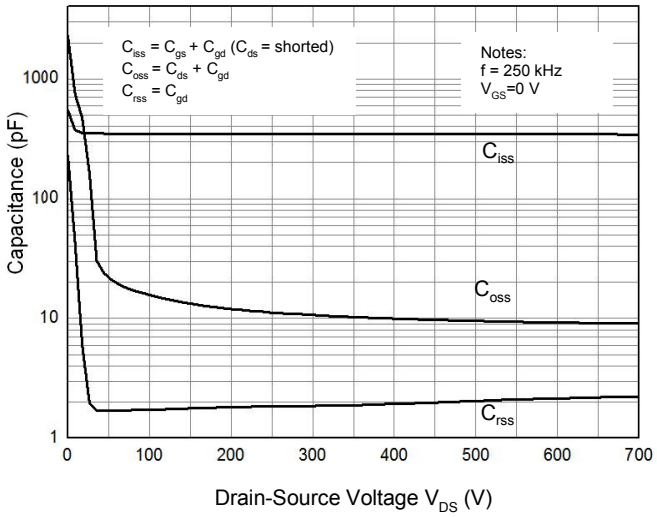


Figure 8. Gate Charge Characterist

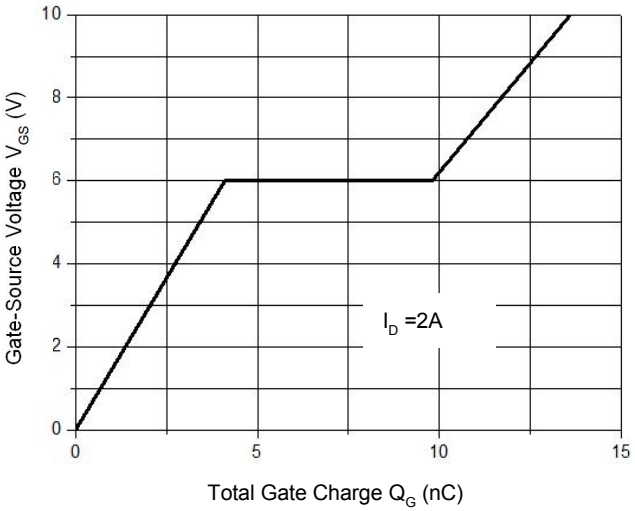


Figure 9.1 Maximum Safe Operating Area
TO-220MF

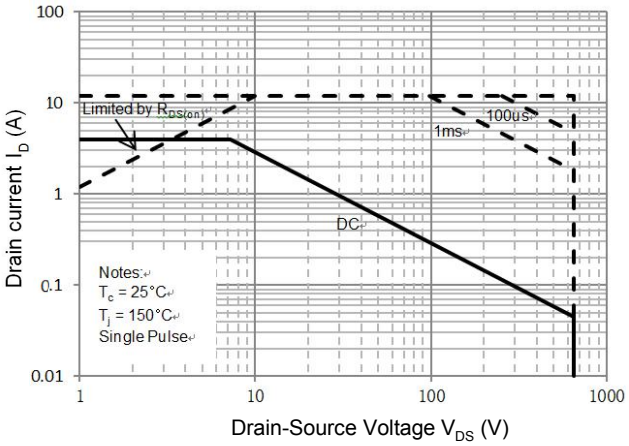


Figure 9.2 Maximum Safe Operating Area
TO-251/TO-252

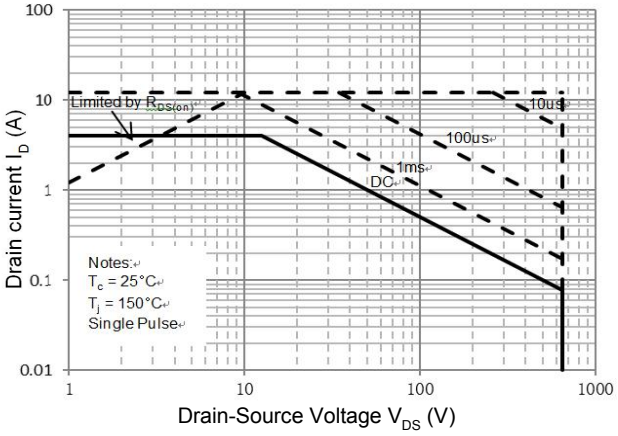


Figure 10.1 Power Dissipation vs. Temperature
TO-220MF

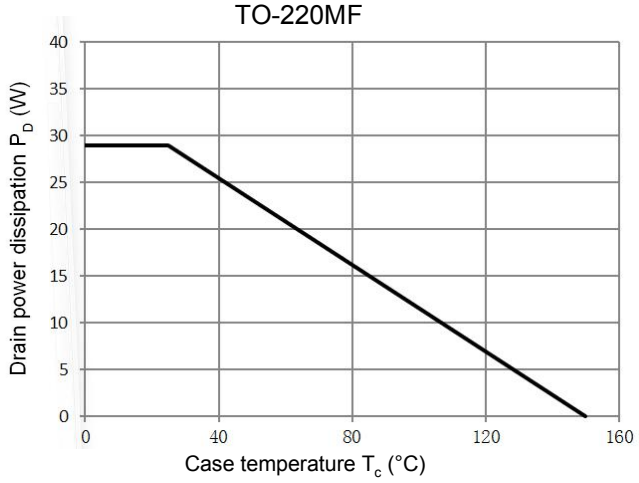


Figure 10.2 Power Dissipation vs. Temperature
TO-251/TO-252

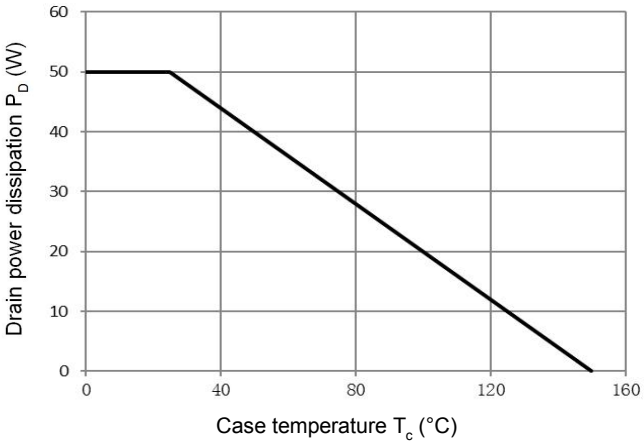


Figure 11.1 Transient Thermal Response Curve

TO-220MF

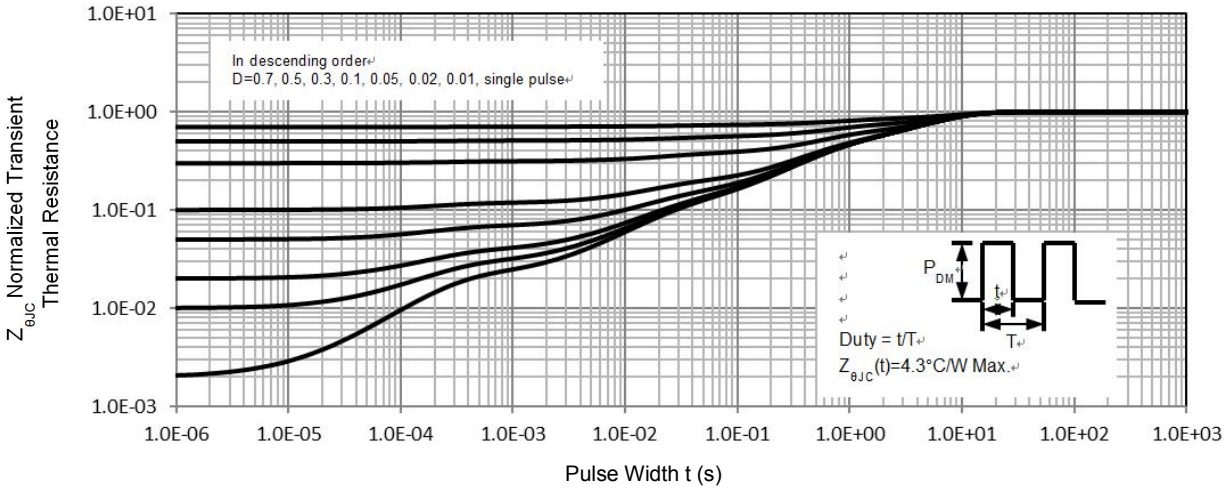
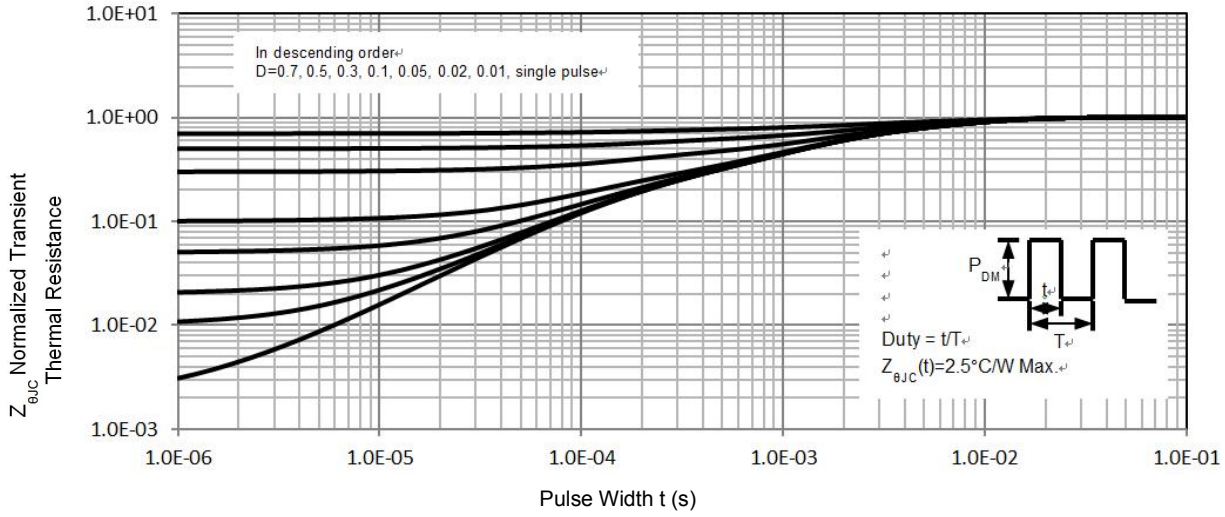
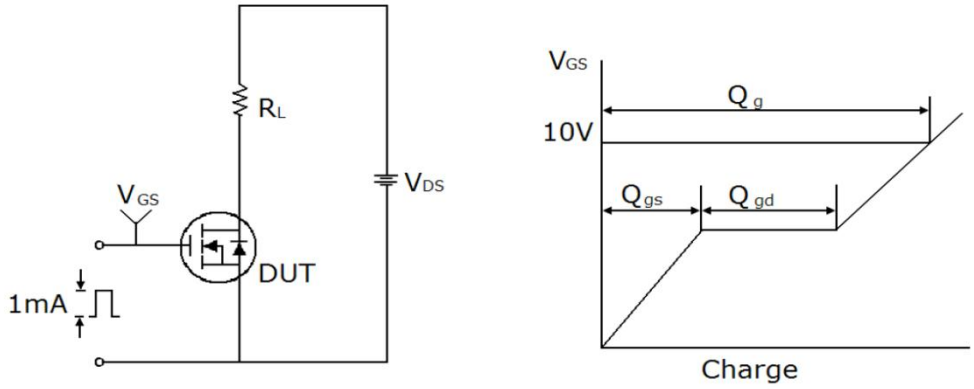


Figure 11.1 Transient Thermal Response Curve

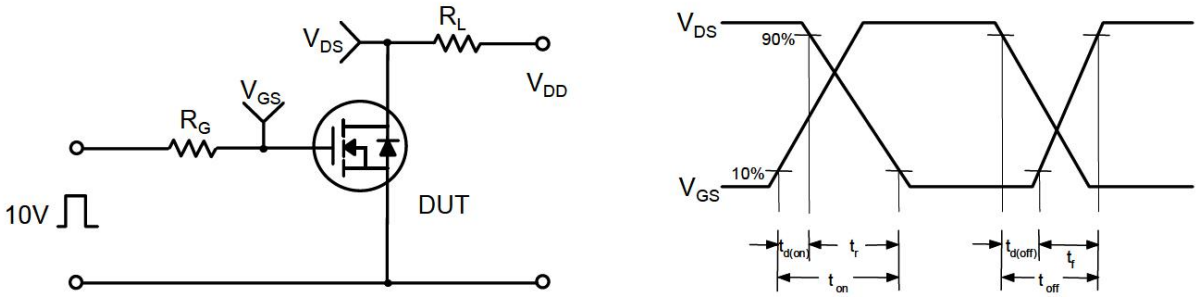
TO-251/TO-252



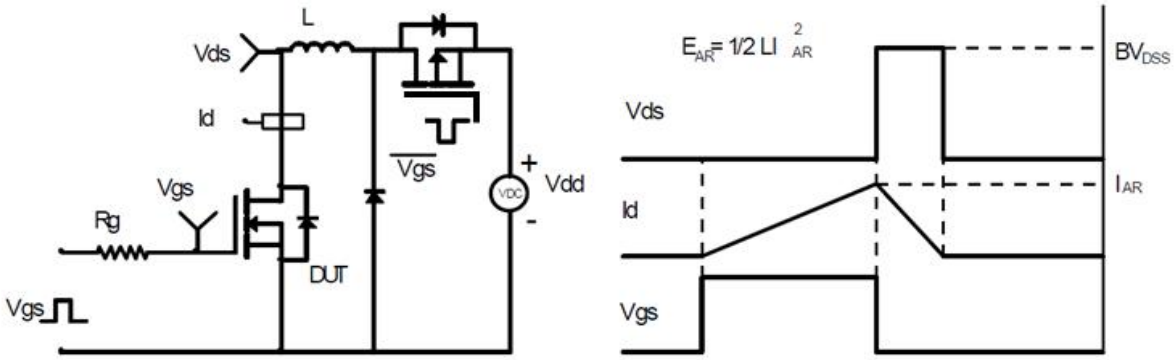
Gate Charge Test Circuit & Waveform



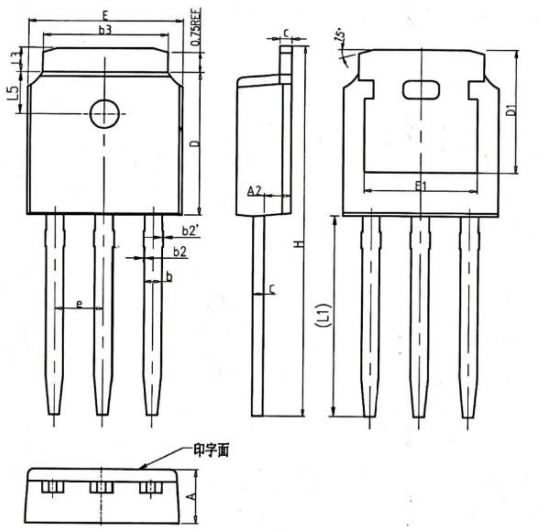
Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

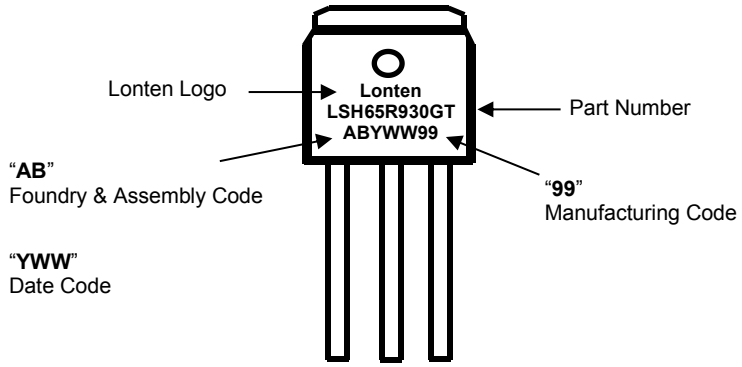


Mechanical Dimensions for TO-251

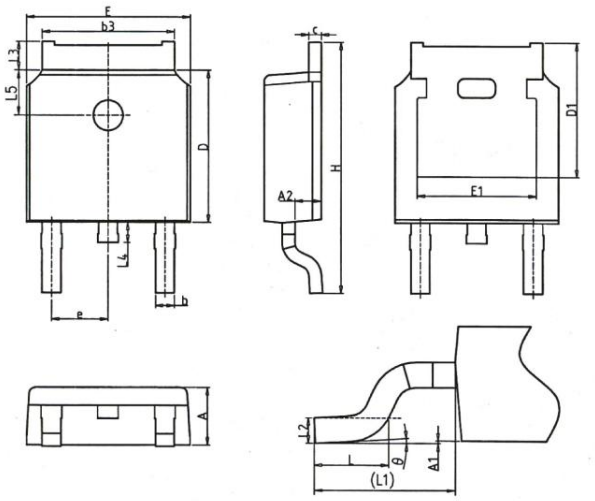


COMMON DIMENSIONS			
SYMBOL	MM		
	MIN	NOM	MAX
A	2.20	2.30	2.38
A2	0.97	1.07	1.17
b	0.68	0.78	0.90
b2	0.00	0.04	0.10
b2'	0.00	0.04	0.10
b3	5.20	5.33	5.46
c	0.43	0.53	0.61
D	5.98	6.10	6.22
D1		5.30REF	
E	6.40	6.60	6.73
E1	4.63	—	—
e		2.286BSC	
H	16.22	16.52	16.82
L1	9.15	9.40	9.65
L3	0.88	1.02	1.28
L5	1.65	1.80	1.95

TO-251 Part Marking Information

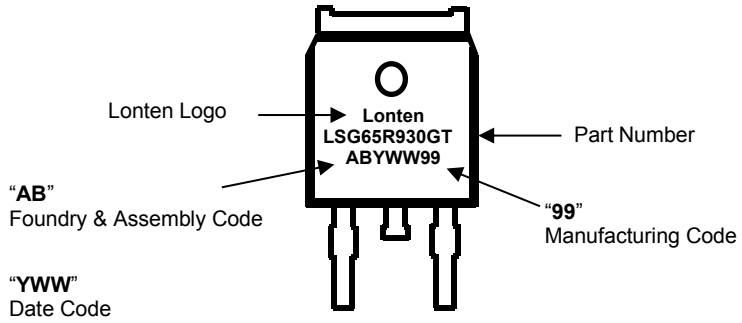


Mechanical Dimensions for TO-252

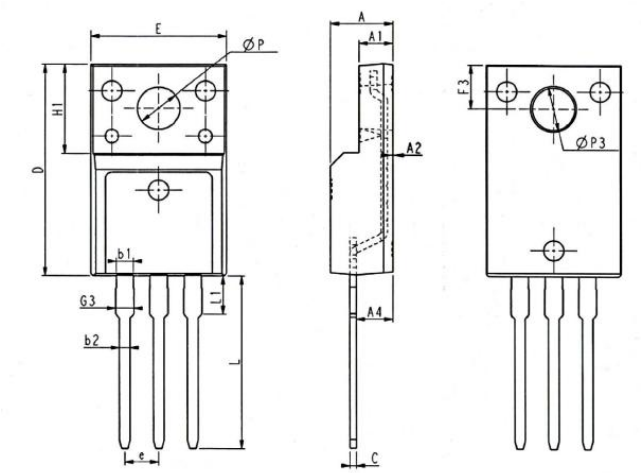


COMMON DIMENSIONS			
SYMBOL	mm		
	MIN	NOM	MAX
A	2.20	2.30	2.38
A1	0.00	—	0.20
A2	0.97	1.07	1.17
b	0.68	0.78	0.90
b3	5.20	5.33	5.46
c	0.43	0.53	0.61
D	5.98	6.10	6.22
D1	5.30REF		
E	6.40	6.60	6.73
E1	4.63	—	—
e	2.286BSC		
H	9.40	10.10	10.50
L	1.38	1.50	1.75
L1	2.90REF		
L2	0.51BSC		
L3	0.88	—	1.28
L4	0.50	—	1.00
L5	1.65	1.80	1.95
θ	0°	—	8°

TO-252 Part Marking Information

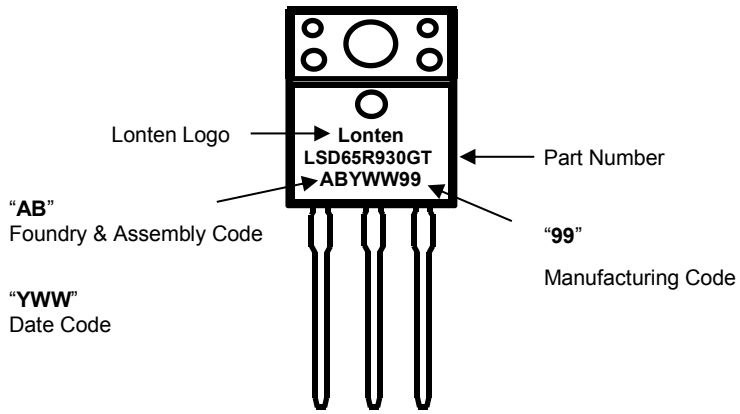


Mechanical Dimensions for TO-220MF



COMMON DIMENSIONS						
SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
E	9.96	10.16	10.36	0.392	0.400	0.408
A	4.50	4.70	4.90	0.177	0.185	0.193
A1	2.34	2.54	2.74	0.092	0.100	0.108
A2	0.30	0.45	0.60	0.012	0.002	0.024
A4	2.65	2.76	2.96	0.104	0.109	0.117
C	0.40	0.50	0.65	0.016	0.020	0.026
D	15.57	15.87	16.17	0.613	0.625	0.637
H1	6.70REF			0.264REF		
e	2.54BSC			0.1BSC		
ØP	3.03	3.18	3.38	0.119	0.125	0.133
L	12.68	12.98	13.28	0.499	0.511	0.523
L1	2.88	3.03	3.18	0.113	0.119	0.125
ØP3	3.15REF			0.124REF		
F3	3.15	3.30	3.45	0.124	0.130	0.136
G3	1.25	1.35	1.55	0.049	0.053	0.061
b1	1.18	1.28	1.43	0.046	0.050	0.056
b2	0.70	0.80	0.95	0.028	0.031	0.037

TO-220MF Part Marking Information



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